

3D-NAND Flash

(TOSHIBA BICS FLASHTM)

2.5" Rugged Metal SATA III SSD

MUSE-ER Series

(7mm & 9.5mm Thickness)

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ISO 9001 : 2015 CERTIFIED















Product Features

■ Flash IC

- TOSHIBA BICS FLASH™.*3
- 3D-NAND Flash

■ Compatibility

- Compliant with SATA Revision 3.2
- SATA 1.5Gb/s; SATA 3Gb/s & SATA 6Gb/s
- Interface compatible.
- ATA-8 ACS4 command set

■ Additional Capabilities

- S.M.A.R.T.*1 (Self-Monitoring, Analysis and Reporting Technology) feature set support.
- Native Command Queuing (NCQ) support.
- TRIM maintenance command support.
- Support Static wear-leveling algorithm
- Hardware Low Density Parity Check Code, LDPC support.
- Support bad Block Management
- Support DRAM buffer which is support high transfer rate as a data buffer for the SSD

■ Mechanical

- Standard 2.5" SATA Flash Disk form-factor (7mm)
- SATA 7-pin (data) + 15-pin (power connector) SATA
 Interface
- Dimension:

128GB to 2TB: 100.0 mm x 69.9 mm x 7.0 mm. **4TB:** 100.0 mm x 69.9 mm x 9.5 mm.

- Weight:

128GB to 2TB: 65.0 g / 2.29 oz.

4TB: 75.0 g / 2.64 oz.

■ Power Operating Voltage 5V(+/-) 5%

Read Mode: 912.0 mA (4TB RMS.)

- Write Mode: 1,066.0 mA (4TB RMS.)

- Idle Mode: 603.0 mA (4TB RMS.)

■ Performance (Maximum value) *2

- Sequential Read: 560.0 MB/sec. (max.)

- Sequential Write: 525.0 MB/sec. (max.)

- 4KB Random Read IOPS (QD32): 87.0K (max.)

- 4KB Random Write IOPS (QD32): 70.0K (max.)

■ Capacity

- 128GB, 256GB, 512GB, 1TB, 2TB and 4TB

Reliability

- **TBW:** Up to 4,800 TBW at 4TB Capacity.

(Client workload by JESD-219A)

 ECC: Designed with hardware LDPC ECC engine with hard-decision and soft-decision decoding.

- Temperature: (Operating)

Standard Grade: 0°C ~ +70°C

Wide Temp. Grade: -40°C ~ +85°C

- Vibration: 70 Hz to 2K Hz, 20G, 3 axes.

- **Shock:** 0.5ms, 1,500G, 3 axes.

Certifications and Declarations

- Certifications: CE & FCC

- **Declarations**: RoHS & REACH

Remarks:

- **1.** Support official S.M.A.R.T. Utility.
- Sequential performance is based on CrystalDiskMark
 1.2 with file size 1000MB
- 3. BiCS means Bit Cost Scalable Technology.

 $\mbox{\bf BiCS FLASH}$ is a trademark of Toshiba Corporation.



Order Information

I. Part Number List

♦ APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series

Product Picture	Grade	Standard grade (0°C ~ 70°C)	Wide Temp. Grade (-40°C ~ +85°C)
	128GB	SR7SR128G-VECT3	WR7SR128G-VECT3-C
0000	256GB	SR7SR256G-VECT3	WR7SR256G-VECT3-C
APRO Co., Ltd. FLASH SSD	512GB	SR7SR512G-VECT3	WR7SR512G-VECT3-C
	1TB	SR7SR001T-VECT3	WR7SR001T-VECT3-C
	2ТВ	SR7SR002T-VECT3	WR7SR002T-VECT3-C
	4TB	SR2SR004T-VECT3	WR2SR004T-VECT3-C

Notes:

C: Special conformal coating treated on whole PCBA (Optional)

II. Part Number Decoder:

X1 X2 X3 X4 X5 X6 X7 X8 X9-X11 X12 X13 X14 X15 - X17 X18 X19 X20

X1 : Grade

S: Standard Grade – operating temp. 0° C ~ 70° C

W: Wide Temp. Grade- operating temp. -40° C ~ +85 ° C

X2 : The material of case

R: Rugged Metal

X3 X4 X5 : Product category

7SR: 2.5" SATA-III SSD 7mm thickness w/DDR DRAM

2SR: 2.5" SATA-III SSD 9.5mm thickness w/DDR DRAM

X6 X7 X8 X9 : Capacity

 128G:
 128GB
 001T:
 1TB

 256G:
 256GB
 002T:
 2TB

 512G:
 512GB
 004T:
 4TB

X11 : Controller

M: MUSE Series

X12 : Controller version

A, B, C.....

X13 : Controller Grade

C: Commercial grade

X14 : Flash IC

T: Toshiba NAND Flash IC

X15 : Flash IC grade / Type

3: BiCS 3D-NAND Flash IC.

X17 X18 X19 X20 : Reserved for specific requirement

C: Conformal coating (optional)



Revision History

Revision	Description	Date
1.0	Initial release.	2019/03/07
2.0	Updated document form	2019/05/22
2.1	Add 4TB Capacity Specifications.	2019/07/19



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1. Introduction

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series provides high capacity flash memory Solid State Drive (SSD) that electrically complies with SATA Revision 3.2. APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series support SATA 1.5Gb/s; SATA 3Gb/s & SATA 6Gb/s data transfer rate and designed with a DRAM buffer which is support high transfer rate as a data buffer for the SSD. The main used flash memories are BiCS 3D-NAND Flash memory chips. The available disk capacities are 128GB, 256GB, 512GB, 1TB, 2TB and 4TB.

The operating temperature grade is optional for standard grade 0° C ~ 70° C and Wide Temp. Grade - 40° C ~ $+85^{\circ}$ C. The data transfer performance by sequential read is up to 560.0 MB/sec, and sequential write is up to 525.0 MB/sec.

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series can be high speed booting SSD to varieties of IPC motherboards and PC structure system, and it is also suitable to handheld device embedded system, inventory recorder and particularly for serious environment monitor recorder system

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series provides a high level interface to the host computer. This interface allows a host computer to issue commands to the APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series to read or write blocks of memory. A powerful hardware design is architecture multiplied LDPC (Low Density Parity Check) for Error Correcting Coding (ECC). APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series intelligent controller manages interface protocols, data storage and retrieval as well as ECC, bad block management and diagnostics, power management and clock control.

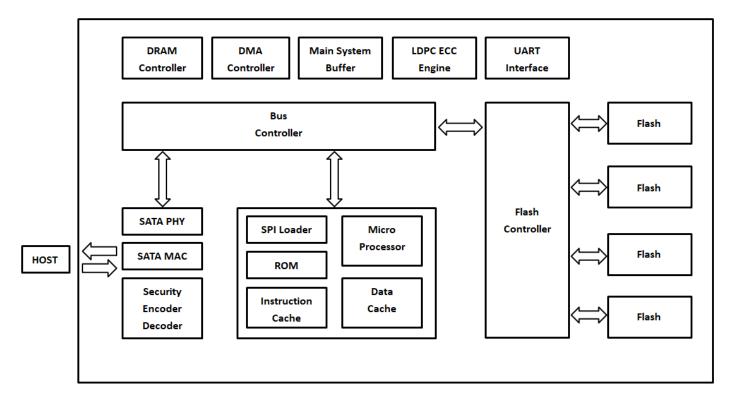


Figure 1: APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series block diagram



1.1. *Scope*

This document describes features, specifications and installation guide of APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series. In the appendix, there provides order information, warranty policy, RMA/DOA procedure for the most convenient reference.

1.2. Flash Management Technology – Static Wear Leveling

In order to gain the best management for flash memory, APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series supports Static Wear-leveling technology to manage the Flash system. The life of flash memory is limited; the management is to increase the life of the flash product.

A static wear-leveling algorithm evenly distributes data over an entire Flash cell array and searches for the least used physical blocks. The identified low cycled sectors are used to write the data to those locations. If blocks are empty, the write occurs normally. If blocks contain static data, it moves that data to a more heavily used location before it moves the newly written data. The static wear leveling maximizes effective endurance Flash array compared to no wear leveling or dynamic wear leveling.

1.3. Bad Block Management

> Early Bad Block

The fault block generated during the manufacturing process of NAND Flash is called Early Bad Block.

Later Bad Block

In the process of use, as the number of operations of writing and erasing increases, a fault block is gradually generated, which is called a Latter Bad Block

Bad block management is a management mechanism for a bad block to be detected by the control IC and mark bad blocks in the NAND Flash and improve the reliability of data access. The bad block management mechanism of the control IC will establish a **Bad Block Table** when the NAND Flash is started for the first time, and will also record the errors found in the process of use in the bad block table, and data is ported to new valid blocks to avoid data loss.

In order to detect the initial bad blocks to handle run time bad blocks, APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series provides the **Bad Block Management** scheme. It remaps a bad block to one of the reserved blocks so that the data contained in one bad block is not lost and new data writes on a bad block is avoided.

1.4. DRAM Buffer

SSDs designed with a DRAM buffer which is support high transfer rate as a data buffer for the SSD; SSD with DRAM buffer is able to deliver excellent random data transfer speed.

- > 128GB, 256GB Supports 2GBits DRAM Cache
- > 512GB Supports 4GBits DRAM Cache
- 1TB Supports 8GBits DRAM Cache.
- 2TB Supports 16GBits DRAM Cache.
- > 4TB Supports 32GBits DRAM Cache



1.5. Error Correcting Coding (ECC)

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series provides a high level interface to the host computer. This interface allows a host computer to issue commands to the APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series to read or write blocks of memory. A powerful hardware design is architecture multiplied LDPC (Low Density Parity Check) for Error Correcting Coding (ECC). APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series intelligent controller manages interface protocols, data storage and retrieval as well as ECC, bad block management and diagnostics, power management and clock control.

1.6. 3D-NAND Flash

3D NAND is a vertical implementation of the NAND flash cell memory array. The memory cell transistors forming the NAND string are connected in a series vertically and the memory transistors are changed from the floating-gate type to a trapped charge type. In floating-gate technology, die density is increased by shrinking peripheral circuits and active circuits.

With 3D, holding the X/Y dimension of the die constant, die density is increased through multiple layers of the active circuits on the Z axis. Higher-density 3D NAND die enables applications needing high-density NAND chip solutions.

2. Product Specifications

For all the following specifications, values are defined at ambient temperature and nominal supply voltage unless otherwise stated.

2.1. System Environmental Specifications

Table 1: Environmental Specification

APRO Rugged Metal 2.5" SATA III SSD		Standard Grade	Wide Temp. Grade	
(3D-NAND Flash) MUSE-ER Series		SRxSRxxxx-VECT3 WRxSRxxxx-VECT3		
Tamparatura	Operating:	0°C ~ +70°C	-40°C ~ +85°C	
Temperature	Non-operating:	-20°C ~ +80°C	-50°C ~ +95°C	
Humidity Operating & Non-operating:		10% ~ 95% non-condensing		
Vibration Frequency/Acceleration:		70 Hz to 2K Hz, 20G, 3 axes		
Shock Operating & Non-operating:		0.5ms, 1500 G, 3 axes		
Temperature:		24°C		
Electrostatic Relative Humidity:		49% (RH)		
Discharge (ESD)	+/-4KV:	Device functions are affected, but EUT will be back to its normal or		
	+7-4KV:	operational state automatically.		



2.2. System Power Requirements

Table 2: Power Requirement

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series			
DC Input Voltage (VCC)		5V±5%	
	Reading Mode (RMS):	912.0 mA (4TB.)	
Maximum average value	Writing Mode (RMS):	1,066.0 mA (4TB.)	
	Idle Mode (RMS):	603.0 mA (4TB.)	

2.3. System Performance

Table 3: System Performances

Data Transfer Mode supporting		Serial ATA Gen-III (6.0Gb/s = 768MB/s)					
Maximum Performance 4	Capacity	128GB	256GB	512GB	1TB	2TB	4TB
	Sequential Read (MB/s)	560.0	560.0	560.0	530.0	550.0	500.0
	Sequential Write (MB/s)	135.0	285.0	525.0	460.0	475.0	450.0
	4KB Random Read IOPS (QD32)	42.0K	80.0K	87.0K	87.0K	87.0K	80.0K
	4KB Random Write IOPS (QD32)	37.0K	56.0K	70.0K	70.0K	66.0K	48.0K

Note:

- > The performance was measured using CrystalDiskMarkv5.0; 1GB data size test with SATA 6Gbps host.
- > Samples were built using Toshiba BiCS 3D-NAND FLASH
- > Performance may differ according to flash configuration and platform.

2.4. System Reliability

Table 4: System Reliability

Wear-leveling Algorithms		Static wear-leveling algorithms		
Bad Block Management		Supportive		
ECC Technology		Hardware design LDPC (Low Density Parity Check)		
Erase counts		TOSHIBA BiCS FLASH™ 3D NAND Flash: 3K P/E Cycles		
TBW (Tera Byt	ytes Written)			
	128GB	150.0		
	256GB	300.0		
Compositor	512GB	600.0		
Capacity	1TB	1,172.0		
	2ТВ	2,344.0		
	4TB	4,800.0		

Note:

- Client workload by JESD-219A.
- Samples were built using Toshiba BiCS 3D-NAND FLASH
- > The endurance of SSD could be varying based on user behavior, NAND endurance cycles, and write amplification factor. It is not guaranteed by flash vendor.



2.5. Physical Specifications

Refer to Table 5 and see Figure 2 for APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series physical specifications and dimensions.

Table 5: Physical Specifications of APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series

Length:	100.0 mm	
Width:	69.90 mm	
Thickness: 7.0 mm (9.5 mm for 4TB SSD only)		
Mainle A	65.0 g / 2.29 oz.	
Weight:	75.0 g / 2.64 oz.	

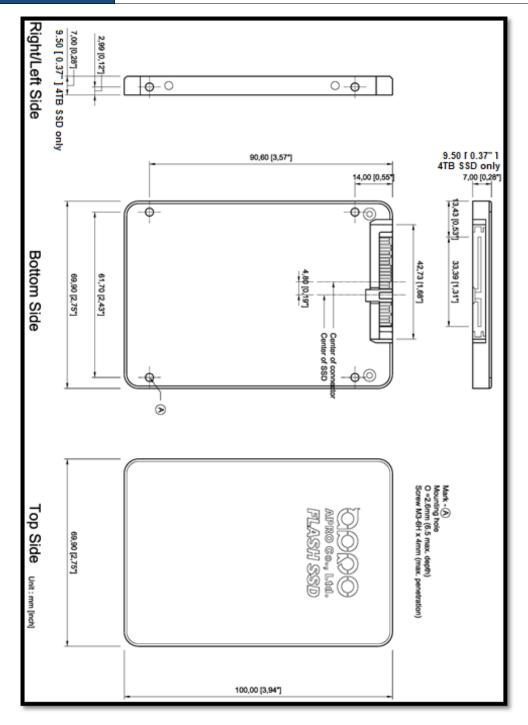


Figure 2: APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series Dimension



2.6. Conformal coating

Conformal coating is a protective, dielectric coating designed to conform to the surface of an assembled printed circuit board. Commonly used conformal coatings include silicone, acrylic, urethane and epoxy. APRO applies only silicone on APRO storages products upon requested especially by customers. The type of silicone coating features good thermal shock resistance due to flexibility. It is also easy to apply and repair.

Conformal coating offers protection of circuitry from moisture, fungus, dust and corrosion caused by extreme environments. It also prevents damage from those Flash storages handling during construction, installation and use, and reduces mechanical stress on components and protects from thermal shock. The greatest advantage of conformal coating is to allow greater component density due to increased dielectric strength between conductors. APRO use MIL-I-46058C silicon conformal coating

3. Interface Description

3.1. Rugged Metal 2.5" SATA III SSD interface

APRO Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series is equipped with 7 pins in the signal segment and 15 pins in the power segment.

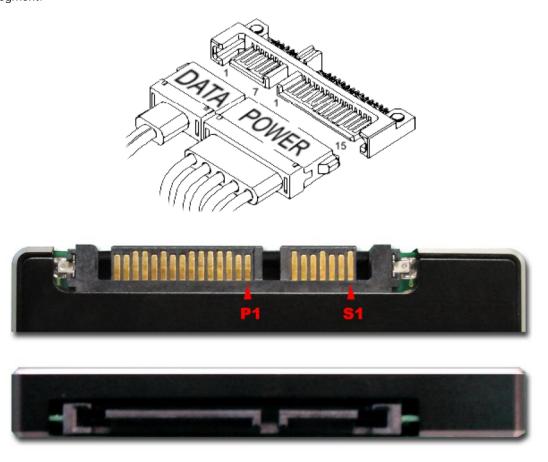


Figure 3: The connectors of Signal Segment and Power Segment



3.2. Pin Assignments

There are total of 7 pins in the signal segment and 15 pins in the power segment.

The pin assignments are listed in below table 6.

Name	Туре	Description
S1	GND	NA
S2	A+	Differential Circuit Dais A
\$3	A-	Differential Signal Pair A
S4	GND	NA
S 5	B-	Differential Circuit Dais D
S6	B+	Differential Signal Pair B
S7	GND	NA

Key and Spacing separate signal and power segments				
P1	NC	NA		
P2	NC	NA		
Р3	NC	NA		
P4	GND	NA		
P5	GND	NA		
P6	GND	NA		
P7	V5	5V Power, Pre-Charge		
P8	V5	5V Power		
P9	V5	5V Power		
P10	GND	NA		
P11	DAS/DSS	Device Activity Signal / Disable Staggered		
P12	GND	NA		
P13	NC	NA		
P14	NC	NA		
P15	NC	NA		

Table 6 - Pin Assignments



Appendix A: Limited Warranty

APRO warrants your Rugged Metal 2.5" SATA III SSD (3D-NAND Flash) MUSE-ER Series against defects in material and workmanship for the life of the drive. The warranty is void in the case of misuse, accident, alteration, improper installation, misapplication or the result of unauthorized service or repair. The implied warranties of merchantability and fitness for a particular purpose, and all other warranties, expressed or implied, except as set forth in this warranty, shall not apply to the products delivered. In no event shall APRO be liable for any lost profits, lost savings or other incidental or consequential damages arising out of the use of, or inability to use, this product.

BEFORE RETURNING PRODUCT, A RETURN MATERIAL AUTHORIZATION (RMA) MUST BE OBTAINED FROM APRO.

Product shall be returned to APRO with shipping prepaid. If the product fails to conform based on customers' purchasing orders, APRO will reimburse customers for the transportation charges incurred.

WARRANTY PERIOD:

• 3D-NAND Flash (Standard grade / Wide Temp. Grade): 2 years / Within 3K Erasing Counts

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